### 502793832 05/02/2014

# PATENT ASSIGNMENT COVER SHEET

EPAS ID: PAT2840427

Electronic Version v1.1
Stylesheet Version v1.2

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
KOSEI NODA	04/09/2014
YUICHI SATO	04/09/2014
YUTA ENDO	04/09/2014

### **RECEIVING PARTY DATA**

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

# **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14263479

### **CORRESPONDENCE DATA**

**Fax Number:** (877)769-7945

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via

US Mail.

 Phone:
 (202) 783-5070

 Email:
 apsi@fr.com

Correspondent Name: JOHN F. HAYDEN

Address Line 1: FISH & RICHARDSON P.C.

Address Line 2: P.O.BOX 1022

Address Line 4: MINNEAPOLIS, MINNESOTA 55440-1022

ATTORNEY DOCKET NUMBER: 12732-1307001

NAME OF SUBMITTER: APRIL K. SAUNDERS-FULLER

SIGNATURE: /April K. Saunders-Fuller/

DATE SIGNED: 05/02/2014

**Total Attachments: 1** 

502793832

source=12732-1307001-ASN#page1.tif

PATENT REEL: 032812 FRAME: 0559

## **ASSIGNMENT**

For valuable consideration, We, <u>Kosei NODA of Atsugi</u>, <u>Kanagawa</u>, <u>Japan</u>, <u>Yuichi SATO of Isehara</u>, <u>Kanagawa</u>, <u>Japan and Yuta ENDO of Atsugi</u>, <u>Kanagawa</u>, <u>Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co., Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for United States Patent signed by us this day, entitled SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF, filed April 28, 2014, and assigned U.S. Serial Number 14/263, 479, and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Signature	Kosei Noda
Name:	Kosei NODA
Date:	04/09/2014
Signature	Yuichi Sato
Name:	Yuichi SATO
Date:	04/09/2014
Signature	Yuta Endo
Name:	Yuta ENDO
Date:	04/09/2014

RECORDED: 05/02/2014

PATENT REEL: 032812 FRAME: 0560